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PART NO. SEE TABLE

REVISIONS			
LTR	DESCRIPTION	Drawing	DATE
A	RELEASE NEW PRODUCT	GARY	11/05/07
B	新增30U"成品料號	GARY	12/15/07
C	新增鍍金封孔成品料號	GARY	12/26/07
D	修改視圖	GARY	04/17/08

CUSTOMER DRAWING

TABLE

PART NO.	PLATED	PLASTIC&COLOR	NOTE
007-01-00548	30U" GOLD (SEAL HOLE)	LCP BLACK	GP
007-01-00549	15U" GOLD (SEAL HOLE)	LCP BLACK	GP
007-01-00539	30 U" GOLD	LCP BLACK	GP
007-01-00523	15 U" GOLD	LCP BLACK	GP

NOTE:

1.MATERIAL :
 BASE : HIGH TEMPERATURE THERMOPLASTIC UL94V-0,
 TERMINAL:COPPER ALLOY,THICKNESS = 0.30 mm
 FORKLOCK:COPPER ALLOY,THICKNESS = 0.30 mm

2.PLATING:
 CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE
 SOLDER TAIL:150u"MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE
 GOLD SPECIFICATION:SEE TABLE
 FORKLOCK:150u" MIN MISTY TIN

3.ELECTRONICAL SPECIFICATION:
 CURRENT RATING: 1.5 AMPERE PER CONTACT
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC.
 OPERATING TEMPERATURE: -40°C~+85°C

剖面圖 A-A

RECOMMENDED PCB LAYOUT

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X ± 0.20 .XX ± 0.15 ANGLE: X ± 3°	APPROVALS		DATE	TITLE: SATA 22P SOCKET DIP 無墊高單柱型
	DRAWN	GARY	04/17/08	
	CHECKED			
	APPROVALS			SIZE mm SCALE : 1 : 1 DRAWING NO. 000554 REV. D
ID NO.	XXXXXXXXXX	SHEET 1 OF 1		

NO DESCRIPTION QTY UNIT DO NOT SCALE DRAWING

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